

# SANYO Semiconductors DATA SHEET

# N-Channel Silicon MOSFET EMH2409 — General-Purpose Switching Device **Applications**

## **Features**

- The EMH2409 incorporates a N-channel MOSFET that feature low ON-resistance and ultrahigh-speed switching, thereby enabling high-density mounting
- 4V drive
- · Halogen free compliance

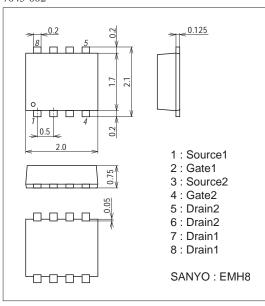
### **Specifications**

#### Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		30	V
Gate-to-Source Voltage	VGSS		±20	V
Drain Current (DC)	ID		4	А
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	16	А
Allowable Power Dissipation	PD	When mounted on ceramic substrate (900mm <sup>2</sup> x0.8mm) 1unit	1.0	W
Total Dissipation	PT	When mounted on ceramic substrate (900mm <sup>2</sup> ×0.8mm)	1.2	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

#### Package Dimensions

unit : mm (typ) 7045-002

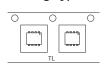


#### **Product & Package Information**

- Package : EMH8
- JEITA, JEDEC
- Minimum Packing Quantity : 3,000 pcs./reel

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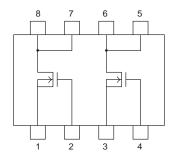
#### Packing Type : TL





Marking

#### **Electrical Connection**



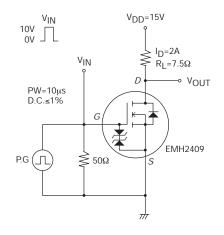
#### SANYO Semiconductor Co., Ltd. http://semicon.sanyo.com/en/network

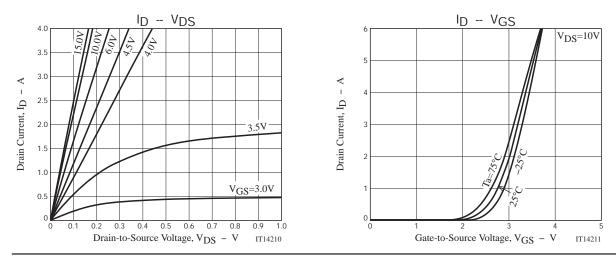
D1510PE TKIM TC-00002532 No. A1890-1/4

#### Electrical Characteristics at Ta=25°C

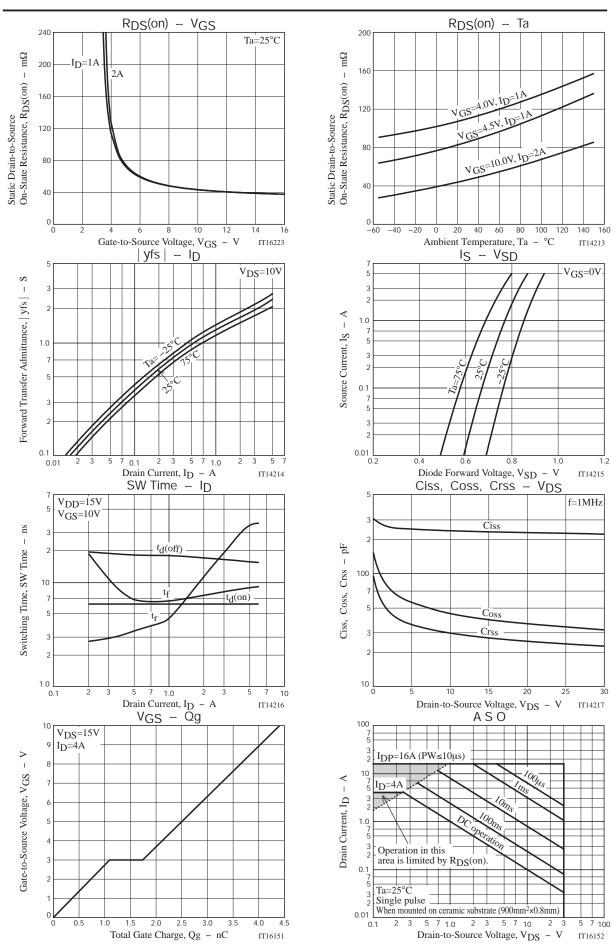
Parameter	Symbol	Conditions	Ratings			Linit
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	30			V
Zero-Gate Voltage Drain Current	IDSS	VDS=30V, VGS=0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	V <sub>GS</sub> =±16V, V <sub>DS</sub> =0V			±10	μΑ
Cutoff Voltage	V <sub>GS</sub> (off)	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA	1.2		2.6	V
Forward Transfer Admittance	yfs	VDS=10V, ID=2A		1.66		S
Static Drain-to-Source On-State Resistance	R <sub>DS</sub> (on)1	ID=2A, VGS=10V		45	59	mΩ
	R <sub>DS</sub> (on)2	ID=1A, VGS=4.5V		85	119	mΩ
	R <sub>DS</sub> (on)3	ID=1A, VGS=4V		110	155	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> =10V, f=1MHz		240		рF
Output Capacitance	Coss	V <sub>DS</sub> =10V, f=1MHz		45		pF
Reverse Transfer Capacitance	Crss	V <sub>DS</sub> =10V, f=1MHz		30		рF
Turn-ON Delay Time	t <sub>d</sub> (on)	See specified Test Circuit.		6.2		ns
Rise Time	tr	See specified Test Circuit.		11		ns
Turn-OFF Delay Time	t <sub>d</sub> (off)	See specified Test Circuit.		17		ns
Fall Time	tf	See specified Test Circuit.		7.5		ns
Total Gate Charge	Qg	V <sub>DS</sub> =15V, V <sub>GS</sub> =10V, I <sub>D</sub> =4A		4.4		nC
Gate-to-Source Charge	Qgs	V <sub>DS</sub> =15V, V <sub>GS</sub> =10V, I <sub>D</sub> =4A		1.1		nC
Gate-to-Drain "Miller" Charge	Qgd	V <sub>DS</sub> =15V, V <sub>GS</sub> =10V, I <sub>D</sub> =4A		0.64		nC
Diode Forward Voltage	V <sub>SD</sub>	IS=4A, VGS=0V		0.82	1.2	V

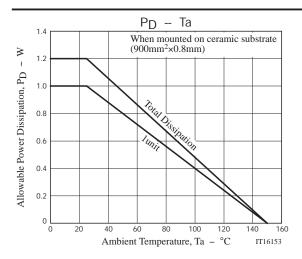
#### Switching Time Test Circuit

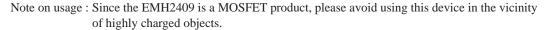


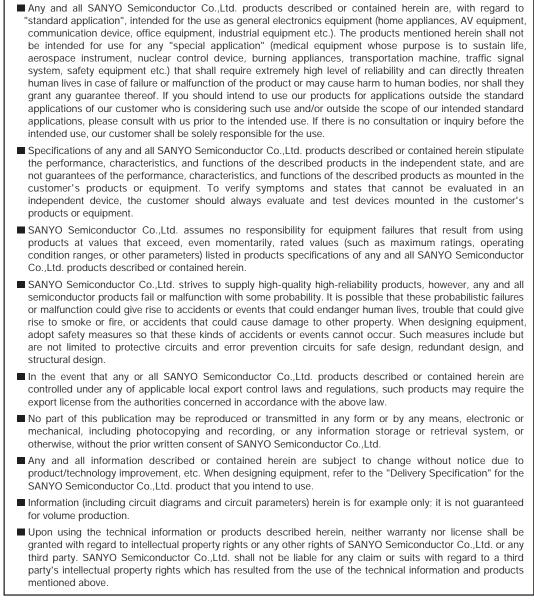


EMH2409









This catalog provides information as of December, 2010. Specifications and information herein are subject to change without notice.